

Data sheet acquired from Harris Semiconductor

## **CMOS Ripple-Carry Binary Counter/Dividers**

High-Voltage Types (20-Volt Rating)

CD4020B - 14 Stage CD4024B - 7 Stage CD4040B - 12 Stage

■ CD4020B, CD4024B, and CD4040B are ripple-carry binary counters. All counter stages are master-slave flip-flops. The state of a counter advances one count on the negative transition of each input pulse; a high level on the RESET line resets the counter to its all zeros state. Schmitt trigger action on the input-pulse line permits unlimited rise and fall times. All inputs and outputs are buffered.

The CD4020B and CD4040B types are supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic packages (E suffix), 16lead ceramic flat packages (K suffix), and in chip form (H suffix).

The CD4024B types are supplied in 14-lead hermetic dual-in-line ceramic packages (D and F suffixes), 14-lead dual-in-line plastic packages (E suffix), and in chip form (H suffix).

### Features:

- Medium-speed operation
- Fully static operation
- Buffered inputs and outputs
- 100% tested for quiescent current at 20 V
- Standardized, symmetrical output characteristics
- Fully static operation
- Common reset
- 5-V, 10-V, and 15-V parametric ratings
- Maximum input current of 1 µA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full package-tempera-

ture range):

1 V at V<sub>DD</sub> = 5 V

2 V at V<sub>DD</sub> = 10 V

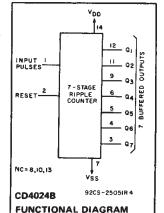
2.5 V at VDD = 15 V

■ Meets all requirements of JEDEC Tentative Standard No. 138, "Standard Specifications for Description of 'B' Series CMOS Devices"

### Applications:

- Control counters
- Frequency dividers
- Timers
- Time-delay circuits

CD4020B, CD4024B, CD4040B Types



CD4020B FUNCTIONAL DIAGRAM

RESET

OUTPUTS

09

-012

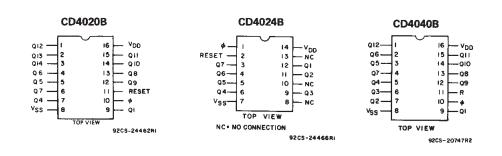
Q13

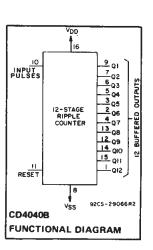
15 QII

910

### MAXIMUM RATINGS, Absolute-Maximum Values: DC SUPPLY-VOLTAGE RANGE, (VDD) Voltages referenced to VSS Terminal) ..... INPUT VOLTAGE RANGE, ALL INPUTS ......-0.5V to V<sub>DD</sub> +0.5V POWER DISSIPATION PER PACKAGE (PD): DEVICE DISSIPATION PER OUTPUT TRANSISTOR OPERATING-TEMPERATURE RANGE (T<sub>A</sub>).....-55°C to +125°C STORAGE TEMPERATURE RANGE (T<sub>stg</sub>).....-65°C to +150°C LEAD TEMPERATURE (DURING SOLDERING):

### **TERMINAL ASSIGNMENTS**





## CD4020B, CD4024B, CD4040B Types

# RECOMMENDED OPERATING CONDITIONS at $T_A = 25^{\circ}$ C, Unless Otherwise Specified For maximum reliability, nominal operating conditions should be selected so that operation

is always within the following ranges:

CHARACTERISTIC		V <sub>DD</sub>	Min.	Max.	UNITS
Supply Voltage Range (at T <sub>A</sub> = Ful Temperature Range)		3	18	V	
Input-Pulse Frequency,	$^{f}_{\phi}$	5 10 15	- - -	3.5 8 12	MHz
Input-Pulse Width,	t <sub>W</sub>	5 10 15	140 60 40	- <del>-</del>	ns
Input-Pulse Rise or Fall Time,	<sup>t</sup> rφ, <sup>t</sup> fφ	5 10 15	Unlimited		μs
Reset Pulse Width,	tw	5 10 15	200 80 60	_	ns
Reset Removal Time,	tREM	5 10 15	350 150 100	- - -	ns

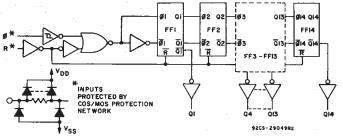


Fig. 1 - Logic diagram for CD40208.

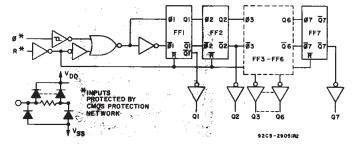


Fig. 2 - Logic diagram for CD4024B.

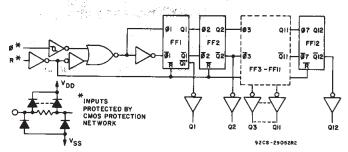


Fig. 3 - Logic diagram for CD4040B.

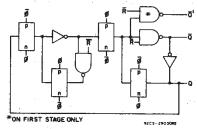


Fig. 4 - Detail of typical flip-flop stage.

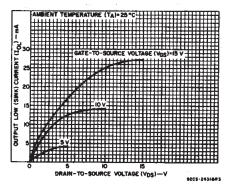


Fig. 5 — Typical output low (sink) current characteristics.

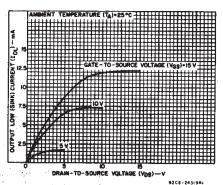


Fig. 6 — Minimum output low (sink) current characteristics.

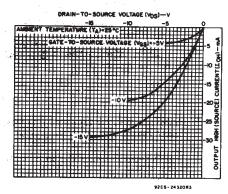


Fig. 7 — Typical output high (source) current characteristics,

## CD4020B, CD4024B, CD4040B Types

## STATIC ELECTRICAL CHARACTERISTICS

CHARACTER- ISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)							
	Vo	VIN	VDD				+25			UNITS	
	(V)	(V)	(V)	-55	-40	+85	+125	Min.	Тур.	Max.	
Quiescent Device Current, IDD Max.		0,5	5	5	5	150	150	<u> </u>	0.04	5	μΑ
		0,10	10	10	10	300	300	-	0.04	10	
	-	0,15	15	20	20	600	600	_	0.04	20	
	_	0,20	20	100	100	3000	3000	-	0.08	100	
Output Low	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1.	-	
(Sink) Current	0.5	0,10	10	1.6	1,5	1.1	0.9	1.3	2.6		
IOL Min.	1.5	0,15	15.	4.2	4	2.8	2.4	34	6.8		
Output High (Source) Current, 1OH Min.	4.6	0,5	. 5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	-	mA
	2.5	0,5	. 5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	-	1.
	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	-	
	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	-	
Output Voltage:		0,5	5	0.05				-	0	0.05	
Low-Level, VOL Max.	_	0,10	10	0.05				_	0	0.05	V
AOF Max	-	0,15	15	0.05				_	0	0.05	
Output Voltage:		0,5	5	4.95				4.95	5		
High-Level,	-	0,10	10	9.95				9.95	10	-	
VOH Min.	-	0,15	15	14.95				14.95	15	-	
Input Low Voltage, VIL Max.	0.5, 4.5		5	1.5				-	-	1.5	
	1, 9	-	10	3				-	_	3	
	1.5,13.5	_	15	4				_	-	4	
Input High Voltage, VIH Min.	0.5, 4.5	_	5	3.5				3.5	_		V
	1, 9	-	10	7				7	_	_	
	1.5,13.5	_·	15	11				11	_		
Input Current IJN Max.	-	0,18	18	±0.1	±0.1	±1	±1	-	±10-5	±0.1	μΑ

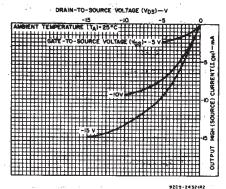


Fig. 8 – Minimum output high (source) current characteristics.

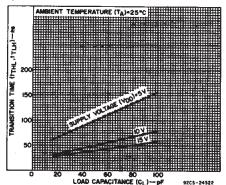
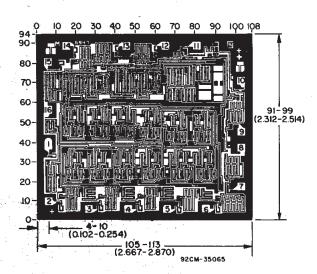
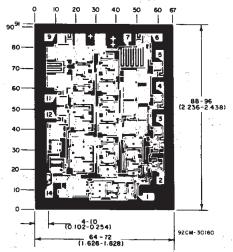


Fig. 9 — Typical transition time as a function of load capacitance.



Dimensions and Ped Layout for CD4020BH. Dimensions and ped layout for CD4040BH are identical.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils  $(10^{-3})$  inch).



Dimensions and Pad Layout for CD4024BH.

## CD4020B, CD4024B, CD4040B Types

## DYNAMIC ELECTRICAL CHARACTERISTICS at T\_A = 25°C, Input t\_r, t\_f = 20 ns, C\_L = 50 pF, R\_L = 200 k $\Omega$

CHARACTERISTIC	TEST CONDITIONS	V <sub>DD</sub> (V)	Min.	Тур.	Max.	UNITS	
Input-Pulse Operation					<u> </u>		
Propagation Delay Time, $\phi$ to $Q_1$ Out; tpHL, tpLH		. 5	_	180	360	ns	
		10		80	160		
		15	_	65	130		
0 4 0 14		_ 5	_	100	330	ns	
Q <sub>n</sub> to Q <sub>n</sub> + 1; <sup>t</sup> PHL <sup>, t</sup> PLH		10		40	80		
		15	_	30	60	1	
Transition Time, <sup>t</sup> THL <sup>, t</sup> TLH		5	-	100	200		
		10	-	50	100	ns	
		15	_	40	80		
Additional Local Date		5		70	140		
Minimum Input-Pulse Width, tw		10	-	30	60	ns	
		15	-	20	40		
		5		μs			
Input-Pulse Rise or Fall		10	] (				
Time, t <sub>rø</sub> , t <sub>fø</sub>		15	1				
Maximum Input-Pulse Frequency, f <sub>\$\phi\$</sub>		5	3.5	7	_		
		10	8	16	-	MHz	
		15	12	24	-	l	
Input Capacitance, C <sub>1</sub>	Any Input		_	5	7.5	₽F	
Reset Operation							
Propagation Delay Time, tp <sub>HL</sub>		- 5	_	140	280		
		10	-	60	120	ns	
		15		50	100	]	
Minimum Reset Pulse Width, t <sub>W</sub>		5		100	200		
		10	_	40	80	ns	
		15		30	60		
Reset Removal Time,		5		175	350	]	
tREM		10	_	75	150	ns	
TEM		15	-	50	100		

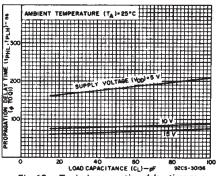


Fig. 10 — Typical propagation delay time as a function of load capacitance  $(\phi \text{ to } Q_1)$ .

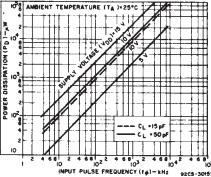


Fig. 11 — Typical dynamic power dissipation as a function of input pulse frequency for CD4020B.

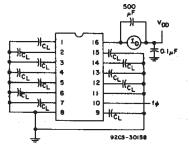


Fig. 12 – Dynamic power dissipation test circuit for CD4020B.

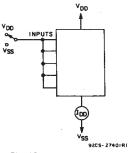


Fig. 13 — Quiescent device current test circuit.

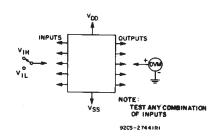


Fig. 14 - Input voltage test circuits.

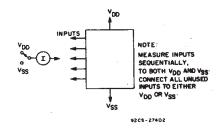


Fig. 15 - Input current test circuit.

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